恒拓电子 HENGTUO ELECTRONICS



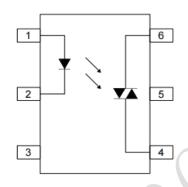
Photo Coupler Product Specification

HT-302X_305X



■ Package





Pin Configuration

- 1 Anode
- Cathode
- No Connection
- Terminal
- No Connection (do not connect)
- Terminal

Description

The HT-302X 305X series of devices each consist of a GaAs infrared emitting diode optically coupled to a monolithic silicon non zero voltage crossing photo triac. They are designed for use with a discrete power triac in the interface of logic systems, such as solid-state relays, industrial controls, motors, solenoids and consumer appliances.

■ Features

- 6pin Non-zero-cross optoisolators triac driver
- High input-output isolation voltage(Viso = 5,000Vrms)
- High repetitive peak off-state voltage VDRM.

HT-302X: Min. 400V;

- HT-305X: Min. 600V;
- High critical rate of rise of off-state voltage(dV/dt : MIN. 1000V /s)
- Operating Temperature: -40 ℃~110 ℃
- Safety approval

UL approved; VDE approved; CQC approved

- RoHS
- MSL1

Applications

- Solenoid/valve controls
- Static power switch
- AC motor drivers
- Temperature Control



■ Product Nomenclature

The product name is designated as below:

<u>HT-30XX X - X X X- XX</u>

1 2 3 4 5

Designation:

HT =Hengtuo Technology Co.,LTD.

30XX= Product Series (302X/305X, X:1/2/3)

- ① = Lead form option(S1,M,NONE)⁽¹⁾
- ② = Tape and Reel option(TP,TP1,NONE)(2)
- ③ = VDE order option(fixed code "V")
- 4 = Halogen free option(fixed code"G")
- ⑤ = Customer code

Notes

1.Lead form option:

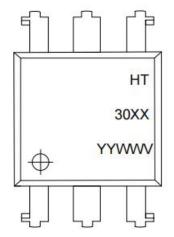
| Symbol | Description |
|--------|-------------|
| S1 | DIP6-S1 |
| М | DIP6-M |
| NONE | DIP6 Normal |

2.Tape and Reel option:

| Symbol | Description |
|--------|--------------------|
| TP&TP1 | Tape and Reel Type |
| NONE | DIP Type |



■ Marking Information



Designation:

HT denotes Hengtuo
30XX denotes Device
YY denotes year code
WW denotes week code

V denotes VDE

■ Maximum

| | Parameter | Symbol | Values | Unit | |
|--------------------------------------|----------------------------------------------------|---------------------|-------------------|------------------------|--|
| | Forward Current | F | 50 | mA | |
| Input | Reverse Voltage | V_R | 6 | V | |
| Input | Power Dissipation | Р | 120 | MW | |
| | Junction Temperature | T_J | 125 | $^{\circ}\!\mathbb{C}$ | |
| | Off-State Output HT-302X | V | 400 | V | |
| | Terminal Voltage HT-305X | V_{DRM} | 600 | V | |
| Output | Peak Repetitive Surge Current (PW=1ms, 120 pps) | Ітѕм | 1 | Α | |
| | On-State RMS Current | I _{T(RMS)} | 100 | mA | |
| | Junction Temperature | T_J | 125 | $^{\circ}\!\mathbb{C}$ | |
| | Collector Power Dissipation | Pc | 150 | mW | |
| Operating temperature range | | T_{opr} | − 40 ~ 110 | ° C | |
| Storage temperature range | | T_{stg} | − 55 ~ 125 | ° C | |
| Total Power consumption | | P(W) | 250 | mW | |
| Isolation Voltage ⁽¹⁾ | | V _{ISO} | 5000 | Vrms | |
| Soldering Temperature ⁽²⁾ | | T _{SOL} | 260 | ° C | |

Notes:

^{(1).} AC for 1 minute, R.H.= $40 \sim 60\%$ R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together.

^{(2).}For 10 seconds



■ Electronic Optical Characteristics

 $(TA = 25^{\circ}C)$

| F | Parameto | er | Symbol | Min. | Тур. | Max. | Unit | Conditon |
|--------|------------------------------------------------|--------------------|------------------|------|------|------|------|--------------------------|
| Innut | Forward V | /oltage | V _F | - | 1.2 | 1.6 | V | I _F =20mA |
| Input | Reverse C | Reverse Current | | - | - | 5 | μA | V _R =6V |
| | Peak Bloc Current, E Direction | ither | I _{DRM} | - | - | 500 | nA | V DRM = Rated VDRM |
| Output | Peak On-Voltage, E | | V _{TM} | - | | 3 | V | ITM=100mA Peak |
| | Critical rate of Rise of Off-State Voltage (2) | | dv/dt | 6 | (- | - | V/µs | Vin=240Vrms |
| | Led Trigger Current,C | HT-3021 HT-3051 | | - | - | 15 | | Main |
| | urrent Required to Latch | HT-3022 HT-3052 | I _{FT} | - | - | 10 | mA | Terminal Voltage = 3V |
| | Output, Either Direction | HT-3023 HT-3053 | | - | - | 5 | | |
| | Holding C Either Dire | | lн | - | 200 | - | uA | - |

⁽¹⁾ Test voltage must be applied within dv/dt rating.

⁽²⁾ This is static dv/dt. Commutating dv/dt is a function of the load-driving thyristor(s) only.



■ Characteristics Curves

Fig.1 Forward current vs.Ambient temperature

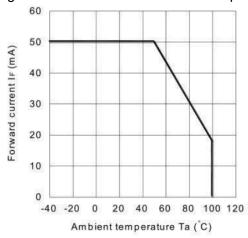


Fig.3 Minimun Trigger Current vs.Ambient temperature

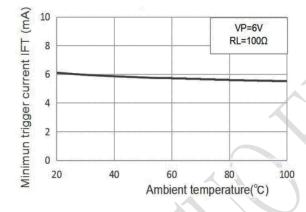


Fig.5 On-state voltage vs . Ambient temperature

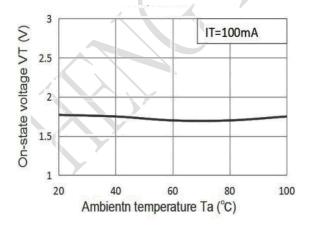


Fig.2 On-state current vs.Ambient temperature

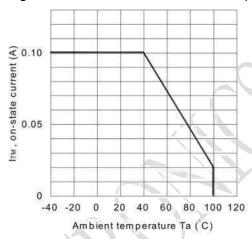


Fig.4 Forward current vs Forward Voltage

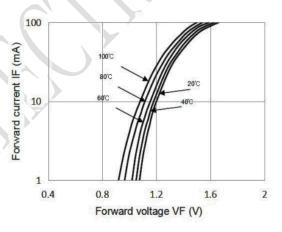


Fig.6 Holding current vs Ambient temperature

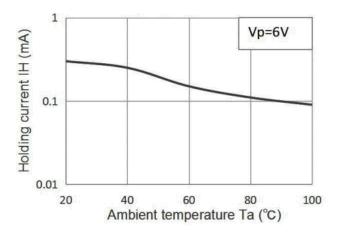




Fig.7 Repetitive peak off-state current vs Temperature

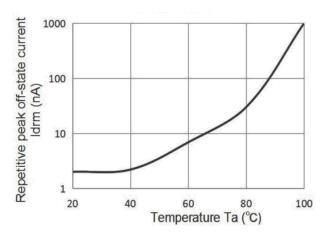


Fig.8 On-state current vs On-state voltage

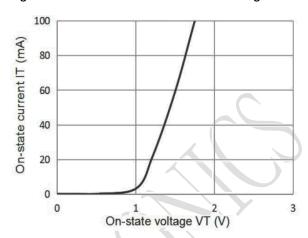
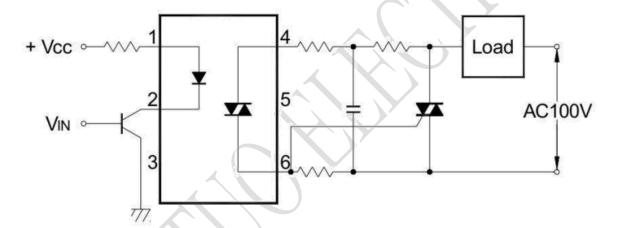


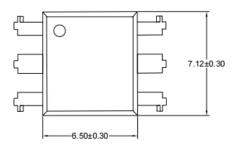
Fig.9 Basic Drver Circuit

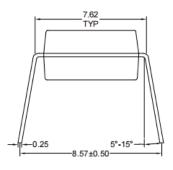


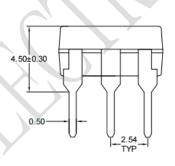


■ Outline Dimension

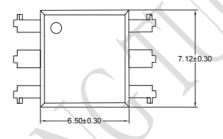
DIP Normal Type:

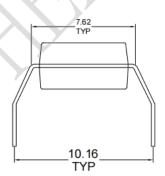


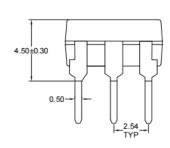




DIP M Type:

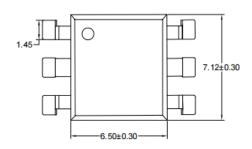


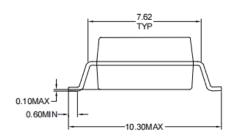


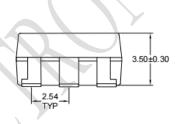




SMD S1 Type:



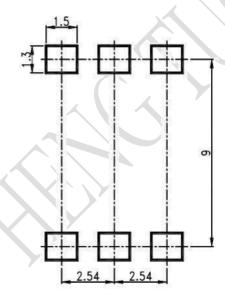




Unit: mm

Tolerance: ±0.1mm

■ Recommended solder pad Design



Unit: mm

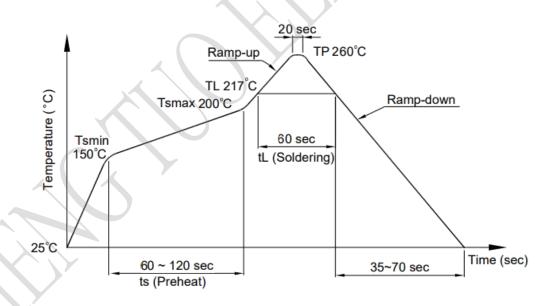
Tolerance: ±0.1mm



■ Temperature Profile Of Soldering

1. IR Reflow soldering (JEDEC-STD-020 compliant)

| Profile item | Conditon |
|-----------------------------------------------------------------------------------|-----------------------------|
| Preheat -Temperature Min (TSmin) -Temperature Max (TSmax) -Time (min to max) (ts) | 150°C 200°C 90±30 sec |
| Soldering zone -Temperature (TL) -Time (tL) | 217°C 60 sec |
| Peak Temperature (TP) | 260°C |
| Ramp-up rate | 3°C / sec max |
| Ramp-down rate | 3~6°C/ sec |

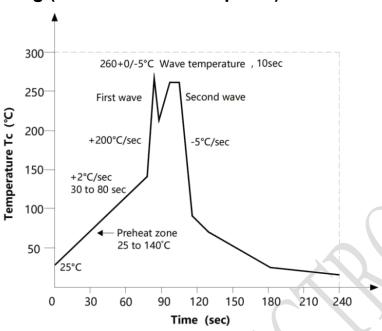


Notes:

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.



2. Wave soldering (JEDEC22A111 compliant)



3. Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

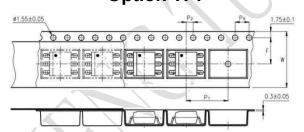
Temperature: 380+0/-5°C

Time: 3 sec max.

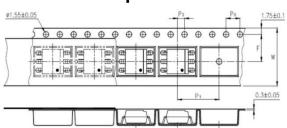
■ Packing

Tape and Reel

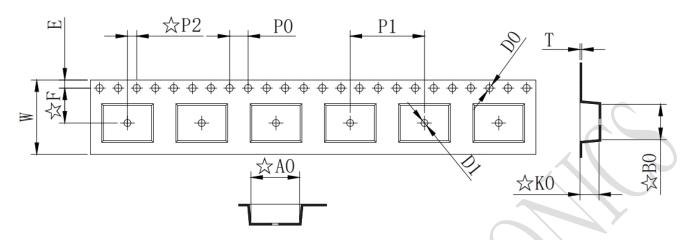
Option TP:



Option TP1:







| Deminsion/mm | W | E | F | P0 | P1 | P2 |
|---------------|--------|----------|---------|-------|--------|-------|
| Packagetype:S | 16±0.2 | 1.75±0.1 | 7.5±0.1 | 4±0.1 | 16±0.1 | 2±0.1 |

| Deminsion/mm | A0 | В0 | D0 | D1 | K0 |
|---------------|-----------|---------|---------|---------|---------|
| Packagetype:S | 10.45±0.1 | 7.6±0.1 | 1.5±0.1 | 1.5±0.1 | 4.1±0.1 |

1.Reel

| Packagetype:S | Reel | Inner carton | Outer carton |
|---------------|---------|--------------|--------------|
| QTY/PCS | 1K/reel | 2K(2 reels) | 20K |

2. Tape and Tube

| Package type:Normal&M | Tube | Outer carton |
|-----------------------|------|----------------|
| QTY/PCS | 66 | 3.3K(50 tubes) |



■ Attention:

- Hengtuo is continually improving the quality, reliability, function or design and Hengtuo reserves the right to make changes without further notices.
- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any "specific" application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.